**Components Marked 'DNP' Should Not Be Populated.**

**Assembly Variant: D01**

<table>
<thead>
<tr>
<th>PCB Viewed From Bottom Side</th>
<th>Board #: PMP10950</th>
<th>Rev: A</th>
<th>Sun Rev: Not In VersionControl</th>
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</thead>
<tbody>
<tr>
<td>PLOT NAME = Bottom Assembly Drawing</td>
<td>GENERATED: 3/25/2015 2:29:49 PM</td>
<td>TEXAS INSTRUMENTS</td>
<td></td>
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